## **Supporting Information for:**

Robust energy storage density and negative capacitance in antiferroelectric heterostructures grown by atomic layer epitaxy

*Yu-Sen Jiang<sup>a</sup>, Yi-Hsuan Chao<sup>a</sup>, Makoto Shiojiri<sup>b</sup>, Yu-Tung Yin<sup>a</sup>, and Miin-Jang Chen<sup>a, b, c, d\**</sup>

<sup>a</sup> Department of Materials Science and Engineering, National Taiwan University, Taipei 10617, Taiwan, R.O.C.

<sup>b</sup> Kyoto Institute of Technology, Kyoto 606-8585, Japan

<sup>c</sup> Graduate Institute of Electronics Engineering, National Taiwan University, Taipei 10617, Taiwan, R.O.C.

<sup>d</sup> Graduate School of Advanced Technology, National Taiwan University, Taipei 10617, Taiwan, R.O.C.

\* Authors to whom any correspondence should be addressed: *E-mail:* mjchen@ntu.edu.tw



**Figure S1.** The epitaxial  $ZrO_2$ /TiN heterostructure was grown on a 6-inch sapphire wafer by atomic layer epitaxy, demonstrating the viability of large-area growth for the mass production of energy storage devices.



**Figure S2.** A unit cell of tetragonal  $ZrO_2$ . The (110) and (101) planes are depicted in purple and green, respectively, intersecting at an angle of 54.5° with each other. The pole axis is the normal of the lattice plane and is indicated by an arrow of the same color. The AFE polar axis of  $ZrO_2$  is along the 110 pole axis, which is the [110] axis in the tetragonal lattice.



**Figure S3.** Dependence of energy storage efficiency on the volume fraction of T-ZrO<sub>2</sub>, as derived from the *P*-*V* curves in Figure 3.



**Figure S4. (a)** The pole figure of the  $T_{0.75}P_{0.25}$  sample at Bragg's angle of TiN(220). **(b)** The stereographic projections of TiN at the (111) pole.

Material and Structure	U <sub>ESD</sub> (J/cm <sup>3</sup> )	P <sub>max</sub> (μC/cm <sup>2</sup> )	Reference
W/ZrO <sub>2</sub> /TiN	118.6	47.7	This work
TiN/HZO/TiN	46	>30	15
Pt/TiO <sub>2</sub> /ZrO2/TiO <sub>2</sub> /Pt	94	>40	28
Cr/TiO <sub>2</sub> /ZrO <sub>2</sub> /TiO <sub>2</sub> /Pt	114.5	>40	29
Pt/HZO/Al <sub>2</sub> O <sub>3</sub> /HZO/TiN	87.66	41.3	31
W/A1:HZO/W	101.4	>30	32
W/HfO2/ZrO2/HfO2/W	32	~28	33
TiN/Al:HZO/TiN	53	~22	34
TiN/Al:HfO <sub>2</sub> /TiN	35	~17	35
TiN/ZrO <sub>2</sub> /TiN	80.2	41.3	36
Mo/ZTSO/Mo	68.59	-	37
W/HAO/W	63.7	-	38
TiN/HZO/Al <sub>2</sub> O <sub>3</sub> /HZO/TiN	55	~32	39
Au/HAO/ZrO <sub>2</sub> /Pt	54.3	-	40
Pt/Al:HfO <sub>2</sub> /Pt	63	-	41
TiN/La:HZO/TiN	50	~30	42
TiN/Si:HZO/TiN	53	-	43
TiN/HZO/TiN	55	~31	44
TiN/Si:HZO/TiN	40	~29	45
TiN/Si:HZO/TiN	61.2	~40	46
TiN/Si:HfO <sub>2</sub> / Si	~40	~30	47
TiN/HZO/TiN	115	~31	48

 Table S1. Benchmark of energy storage density in dielectric capacitors.